Microprocessor Technology & Case Studies

> NBAY 6120 March 6, 2018 Donald P. Greenberg Lecture 2

• Required Reading:

- Craig R. Barrett. From Sand to Silicon: Manufacturing an Integrated Circuit, Scientific American, Special Issue, The Solid-State Century, January 1998, pp. 55-61. (Search: e-Journals/ Scientific American Archive Online/article (full text) http://www.library.cornell.edu/johnson/library/general/emba.html
- Peter J. Denning and Ted G. Lewis. "Exponential Laws of Computing Growth." Communications of the ACM. January 2017. <u>ACM.org</u>.

• Optional Reading:

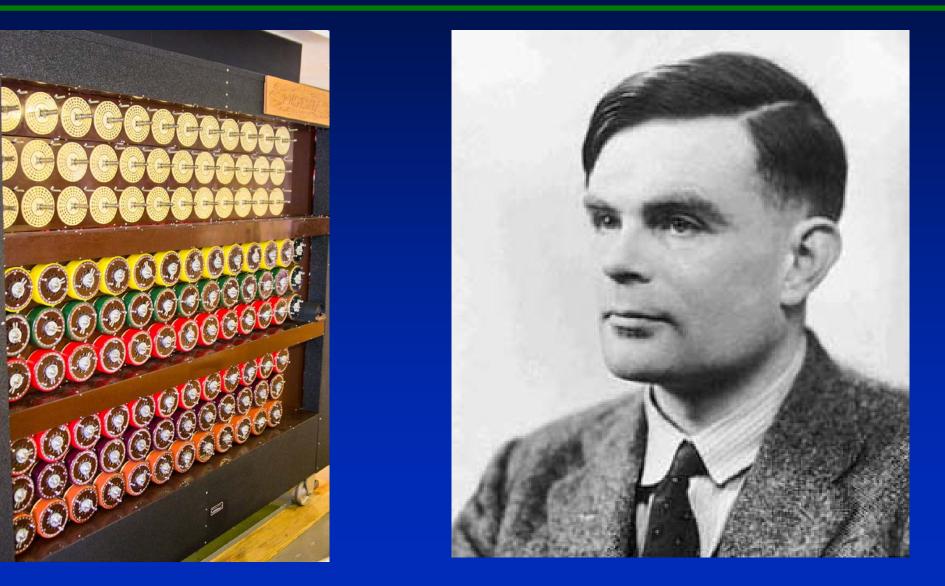
 Mack, Chris. "The Multiple Lives of Moore's Law." *IEEE Spectrum* Apr. 2015: 30-37. *Cornell University Library*. Web. <u>http://ieeexplore.ieee.org/stamp/stamp.jsp?tp=&arnumber=7065415</u>

Economics of the Semiconductor Industry

- Required Reading:
 - G. Dan Hutcheson and Jerry D. Hutcheson. Technology & Economics in the Semiconductor Industry, <u>Scientific American</u>, January 1996.

Bletchley Park

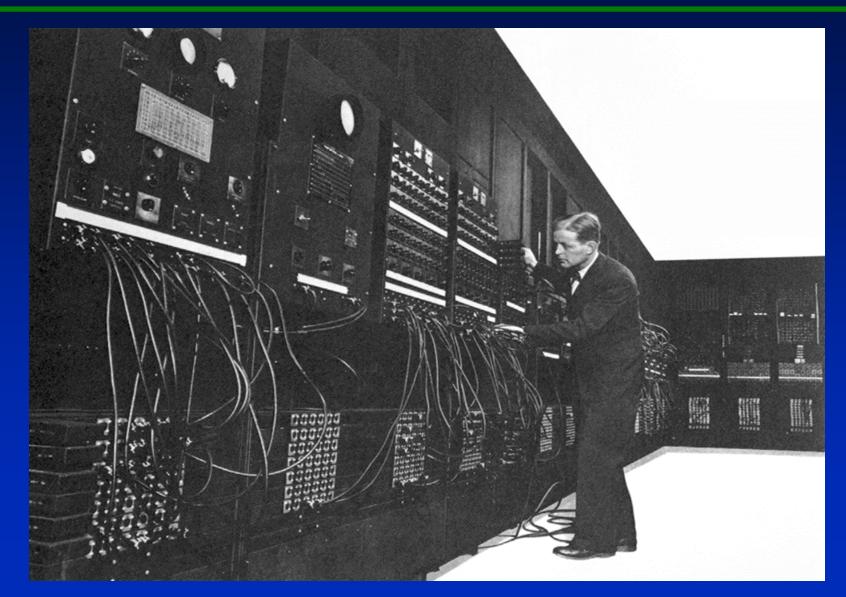
Alan Turing



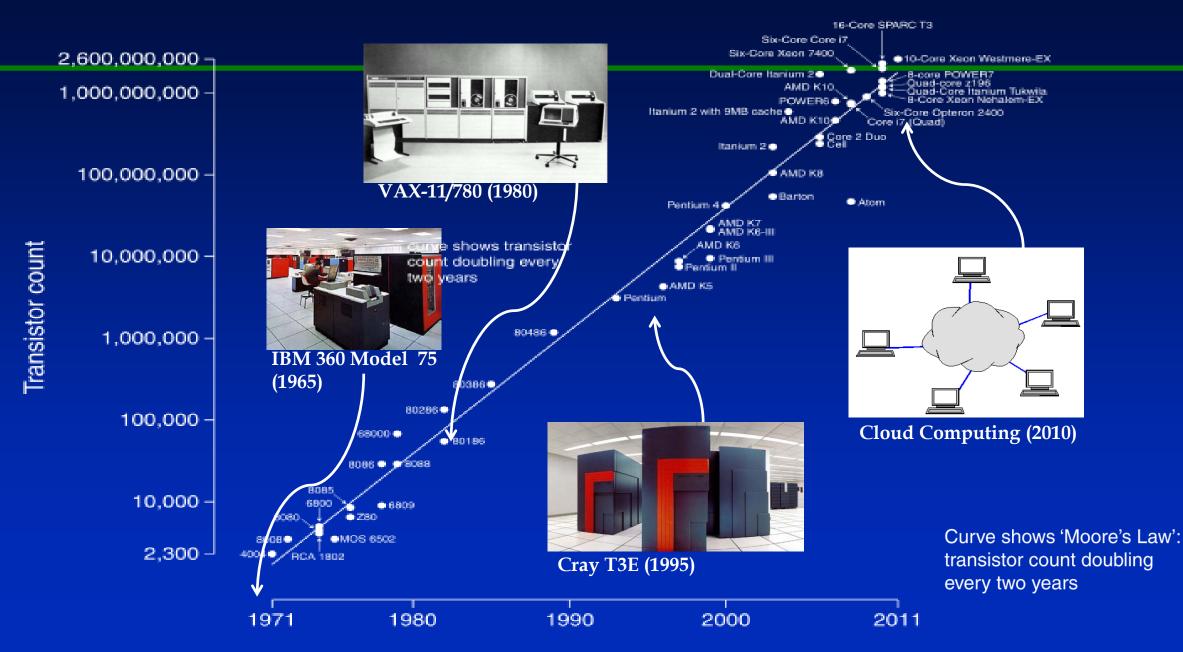
1940s



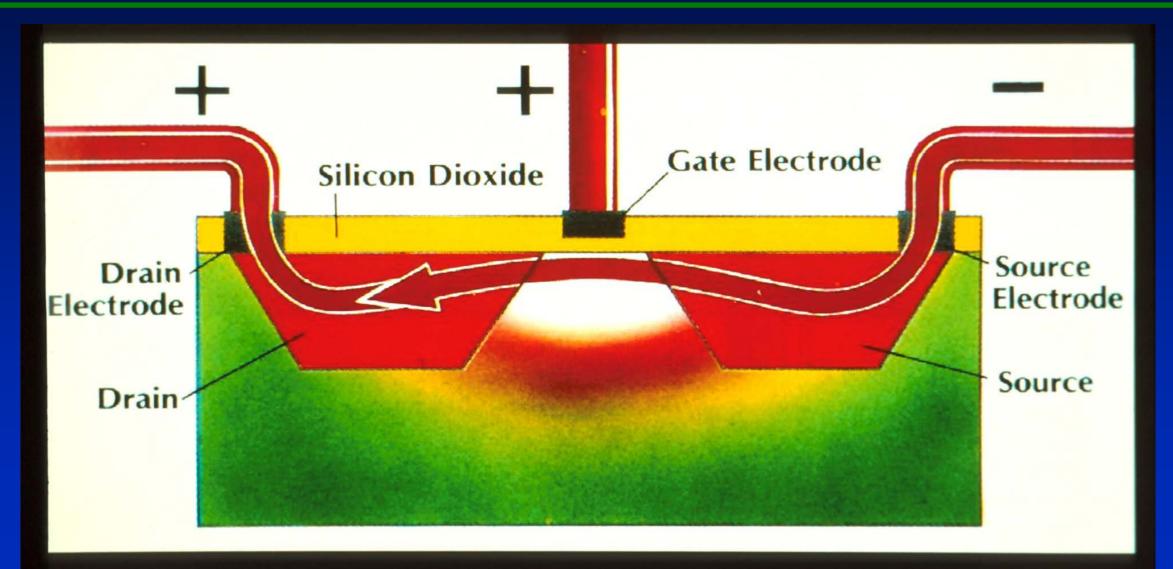




Microprocessor Transistor Counts 1971-2011 & Moore's Law

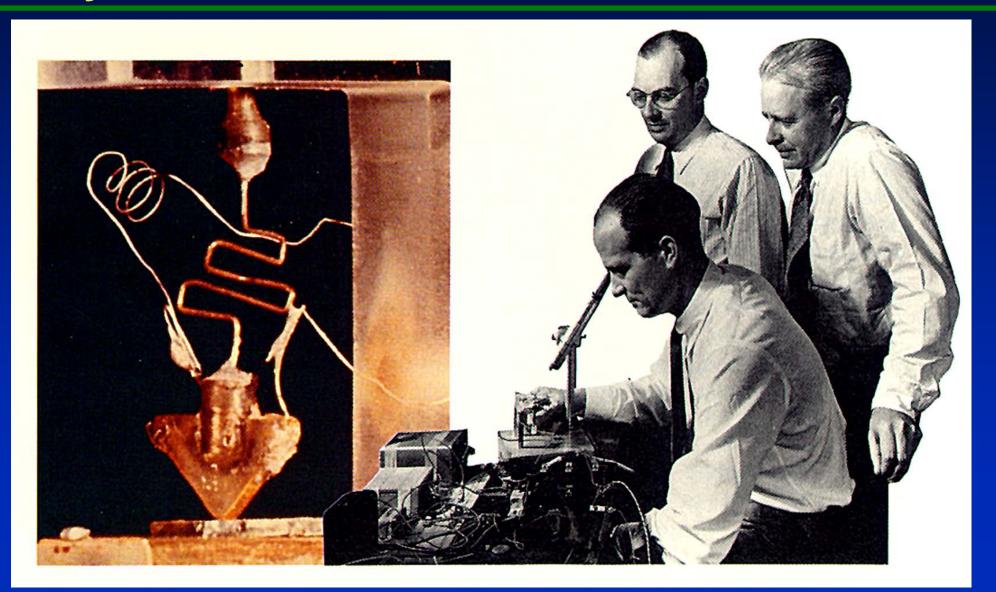


Transistor



Shockley, Bardeen & Brattain

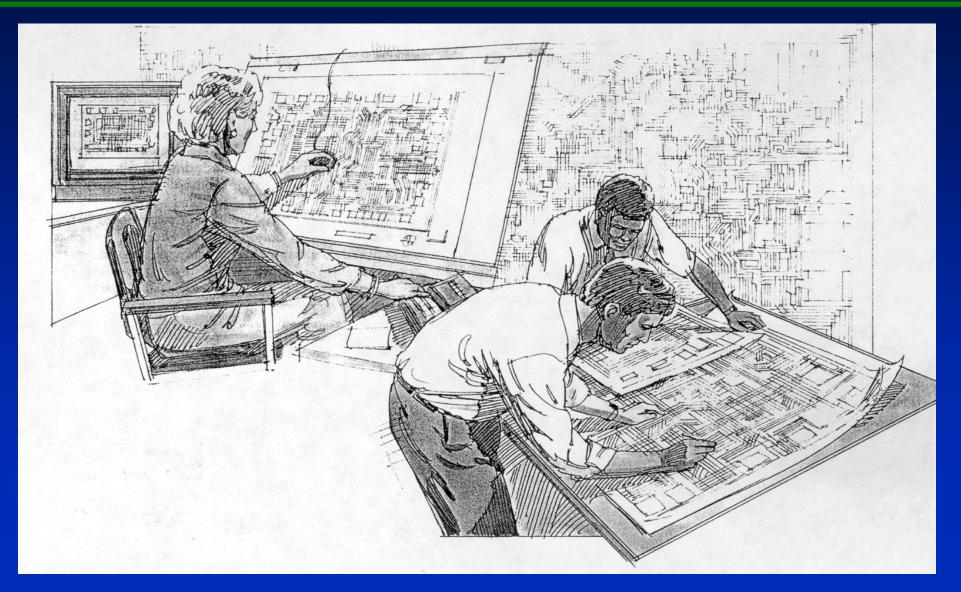




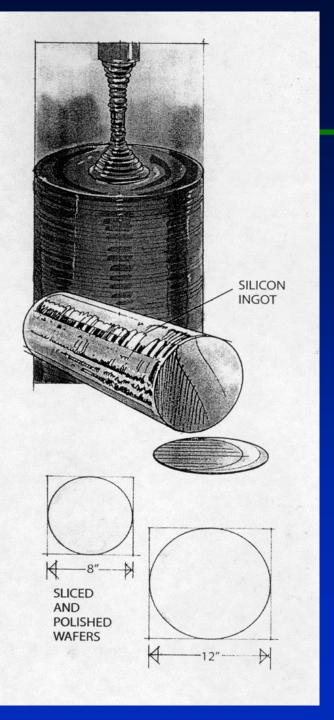
From Sand to Silicon – Manufacturing an Integrated Circuit

Scientific American: The Solid-State Century, Special Issue 1998

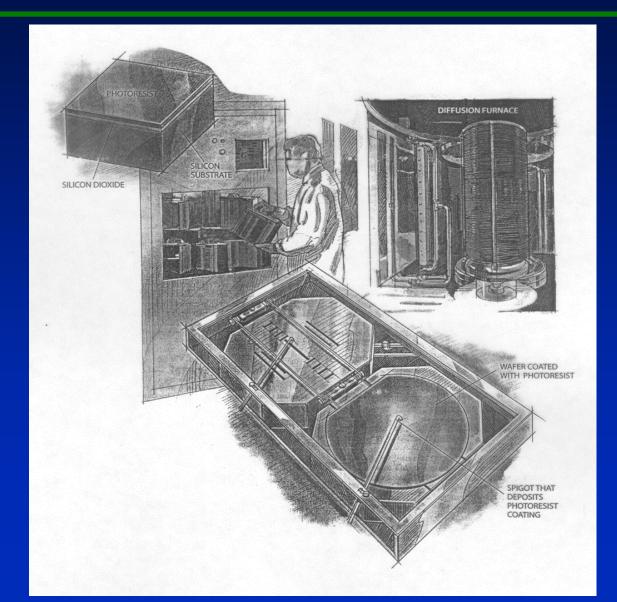
Chip Design



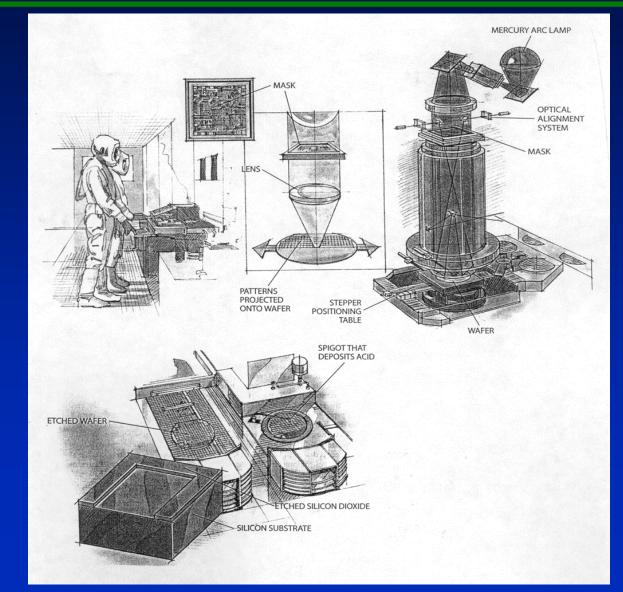
Silicon Crystal



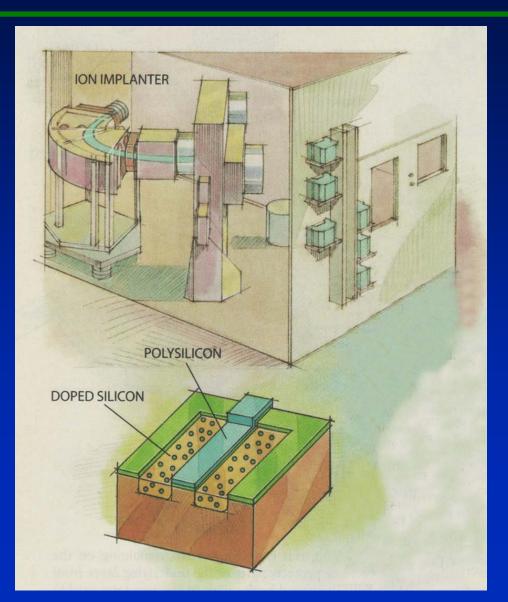
Layering



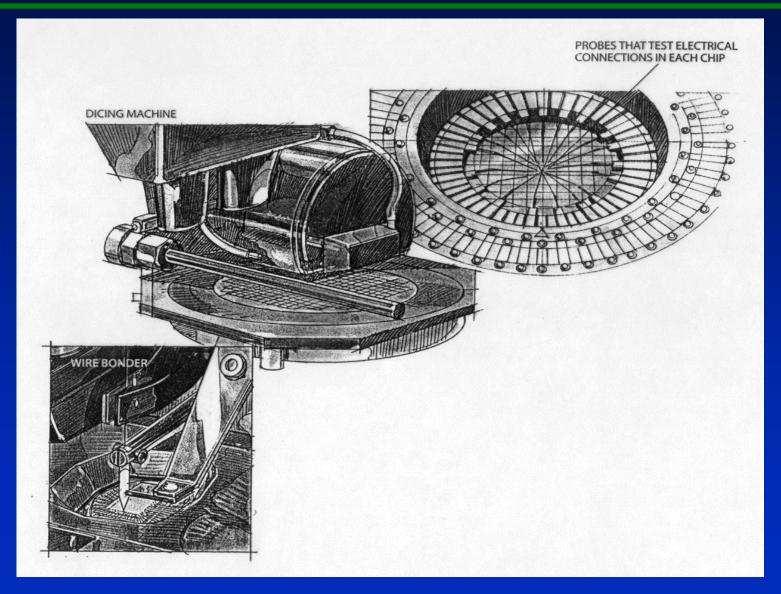
Masking & Etching



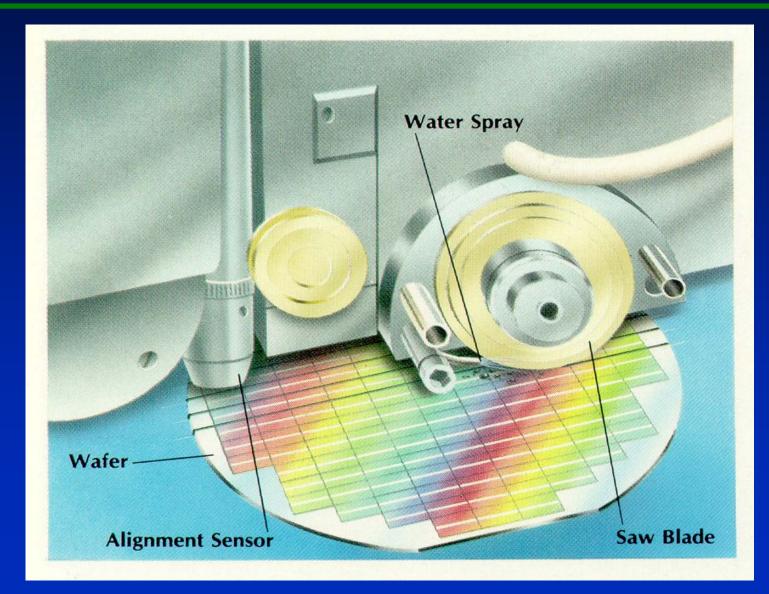
Doping



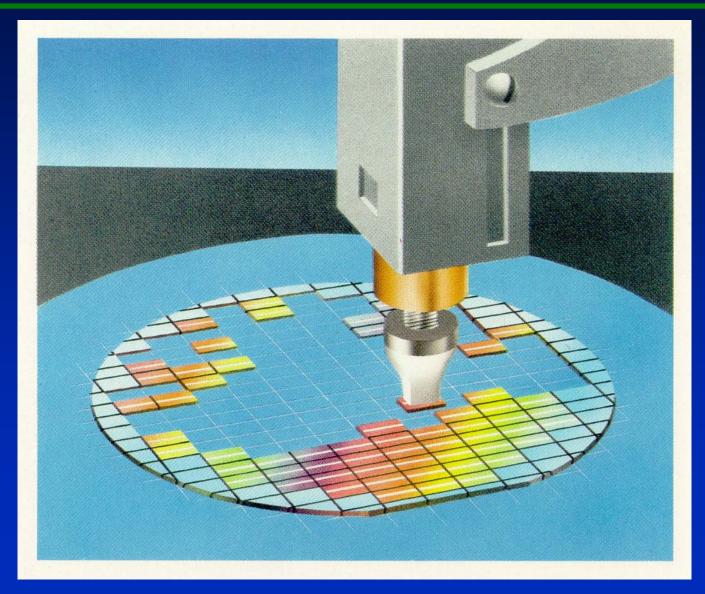
Interconnections & Dicing



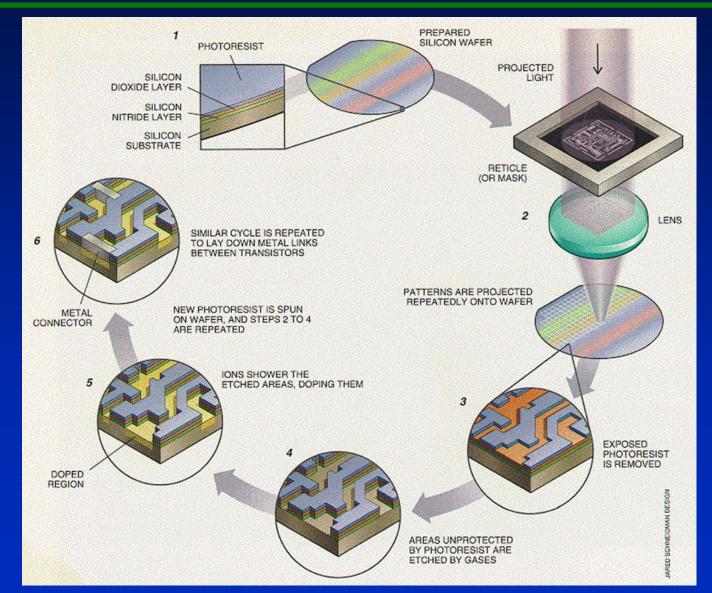
Dicing



Chip Selection



Chip Fabrication

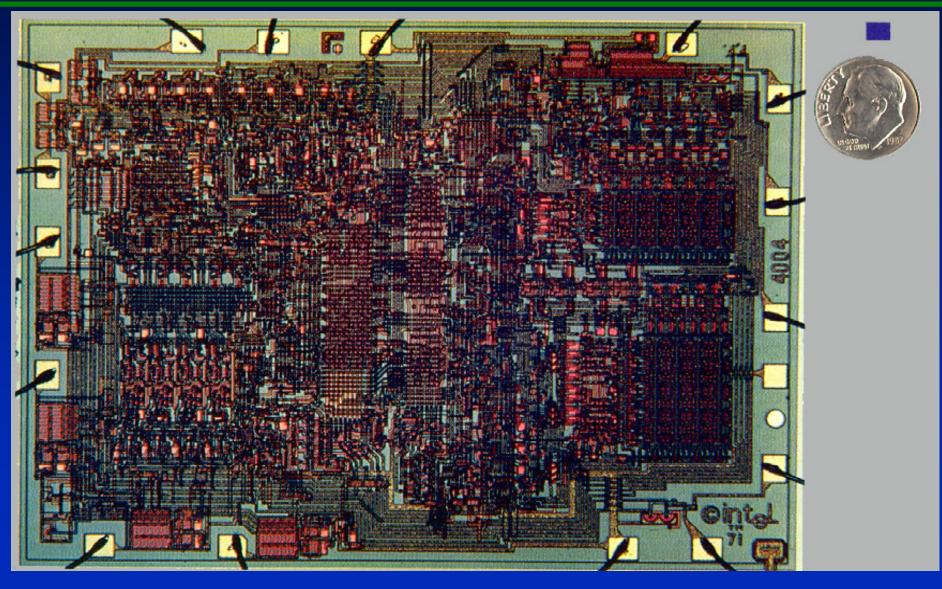


International Technology Roadmap for Semiconductors

	2001	2004	2007	2010	2013	2016		
Technology (nanometers)	130nm	90nm	65nm	45nm	32nm	22nm		
Functions per Chip (millions)	97	193	386	1546	3092	6184		
Clock Speed (Ghz)	2.5Ghz	4.1Ghz	9.3Ghz	15Ghz	23Ghz	40Ghz		
Wafer Size (millimeters)	200mm	300mm	300mm	300mm	450mm	450mm		
Chip Size (mm ²)	140 mm ²							
Roughly 0.5 shrink every 3 years. Intel released 22 nm chips in 2013								

Intel 4004

November 1971

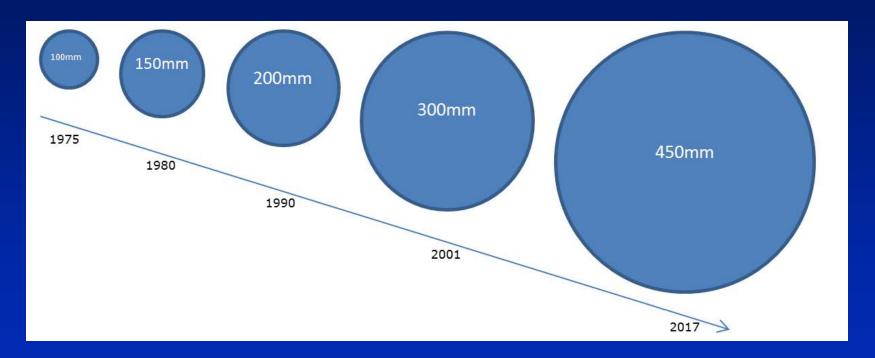


Moore's Law – CPU Transistor Counts

Processor	Transistor count	Date of introduction	Manufacturer	Process	Area
Core 2 Duo	291,000,000	2006	Intel	65 nm	
AMD K10	463,000,000	2007	AMD	65 nm	
AMD K10	758,000,000	2008	AMD	45 nm	
Itanium 2 with 9MB cache	592,000,000	2004	Intel	130 nm	
Core i7 (Quad)	731,000,000	2008	Intel	45 nm	263 mm²
POWER6	789,000,000	2007	IBM	65 nm	341 mm²
Six-Core Opteron 2400	904,000,000	2009	AMD	45 nm	
Six-Core Core i7	1,170,000,000	2010	Intel	32 nm	
Dual-Core Itanium 2	1,700,000,000	2006	Intel	90 nm	596 mm²
Six-Core Xeon 7400	1,900,000,000	2008	Intel	45 nm	
Quad-Core Itanium Tukwila	2,000,000,000	2010	Intel	65 nm	
Six-Core Core i7 (Sandy Bridge-E)	2,270,000,000	2011	Intel	32 nm	434 mm²
8-Core Xeon Nehalem-EX	2,300,000,000	2010	Intel	45 nm	684 mm²
10-Core Xeon Westmere-EX	2,600,000,000	2011	Intel	32 nm	512 mm²
Six-core zEC12	2,750,000,000	2012	IBM	32 nm	597 mm²
8-Core Itanium Poulson	3,100,000,000	2012	Intel	32 nm	544 mm²
15-Core Xeon Ivy Bridge-EX	4,310,000,000	2014	Intel	22nm	541 mm²
62-Core Xeon Phi	5,000,000,000	2012	Intel	22 nm	350 mm²
Xbox One Main SoC	5,000,000,000	2013	Microsoft	28 nm	363 mm²
18-core Xeon Haswell-E5	5,560,000,000	2014	Intel	22 nm	661mm²
IBM z14 Storage Controller	9,700,000,000	2017	IBM	14 nm	696mm ²
32-core SPARC M7	10,000,000,000	2015	Oracle	20 nm	
Centriq 2400	18,000,000,000	2017	Qualcomm	10 nm	398 mm ²
32-core AMD Epyc	19,200,000,000	2017	AMD	14 nm	4× 192 mm2

Paul S. Otellini – Intel Corporation CEO

2007





Why are we continuing to strive for smaller and smaller technology?

● More transistors/chip → increased functionality and performance

 Higher speeds → partially depends on how close together the components are placed

• Cheaper – more chips/wafer, greater yields

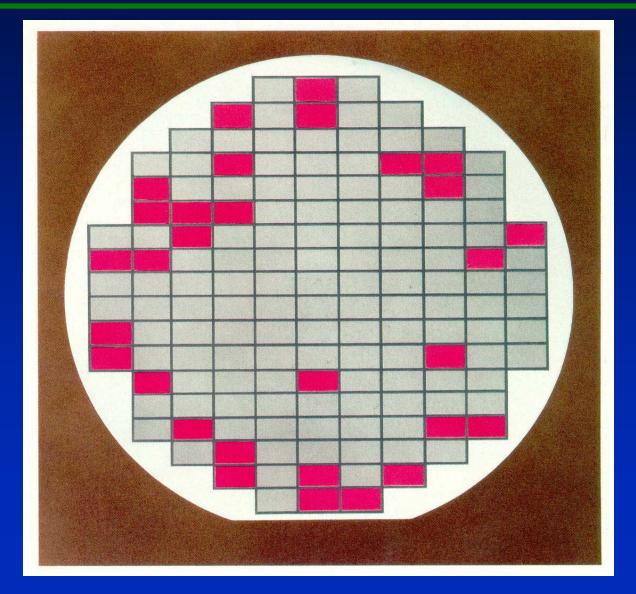
Yield Ratio

$$yield = \frac{n_{w}}{n_{t}}$$
$$n_{w} = yield \bullet n$$

 $n_w =$ number of working chips/wafer $n_t =$ total number of chips/wafer

Old fab lines, yield $\rightarrow > 90\%$ New fab lines, yield $\rightarrow < 40\%$

Yield per Wafer



Yield Ratio

Number of defects/unit area depends on the process

Chip Area Total chips (n_t) for a given wafer size is also inversely proportional to the chip

area

 \therefore Yield \approx

Why does the shrinking technology make the cost of manufacturing cheaper per component?

Example:

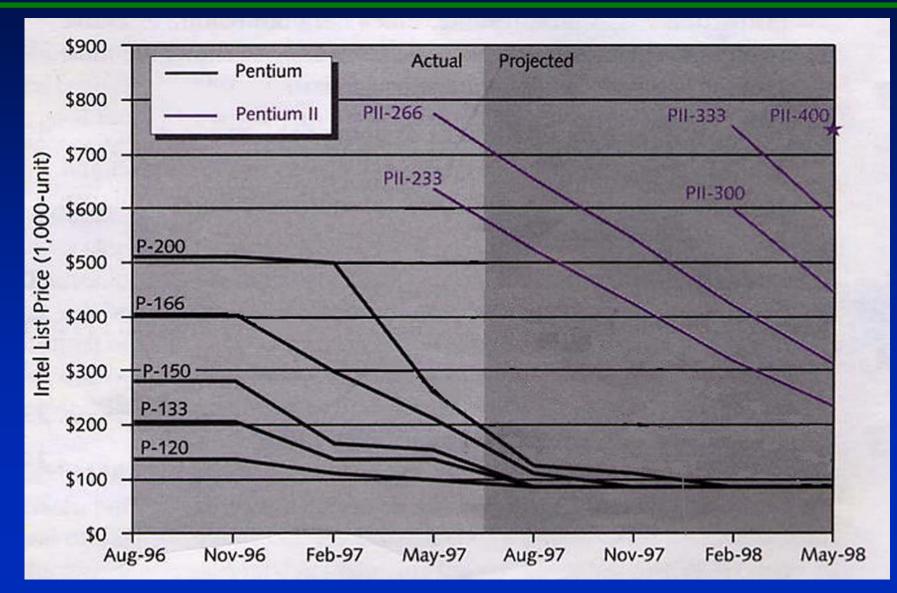
For a 10% shrink in feature size :

$$n_{w_{new}} = n_{w_{old}} \left(\frac{1}{.9}\right)^2 \left(\frac{1}{.9}\right)^2$$

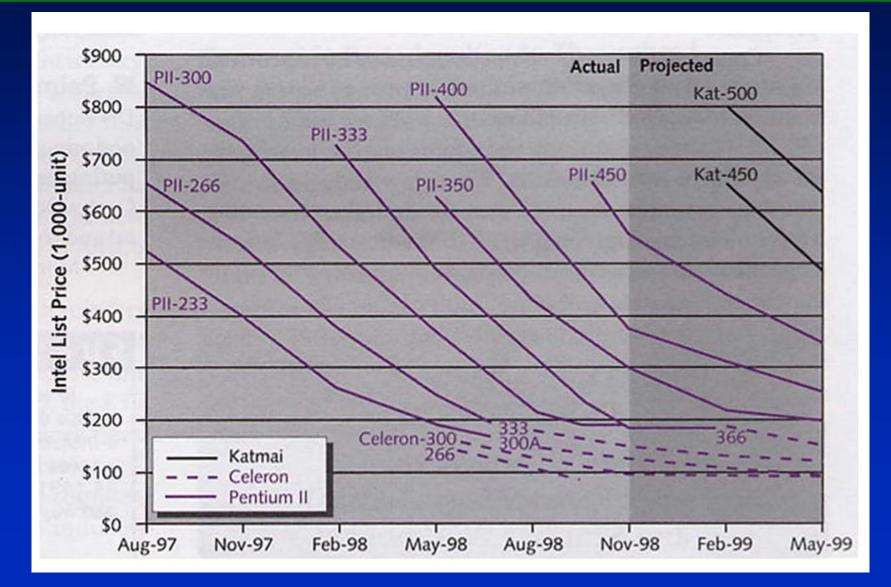
$$\uparrow \quad \uparrow$$
New yield New n

$$n_{w_{new}} = 1.52n_{w_{old}}$$

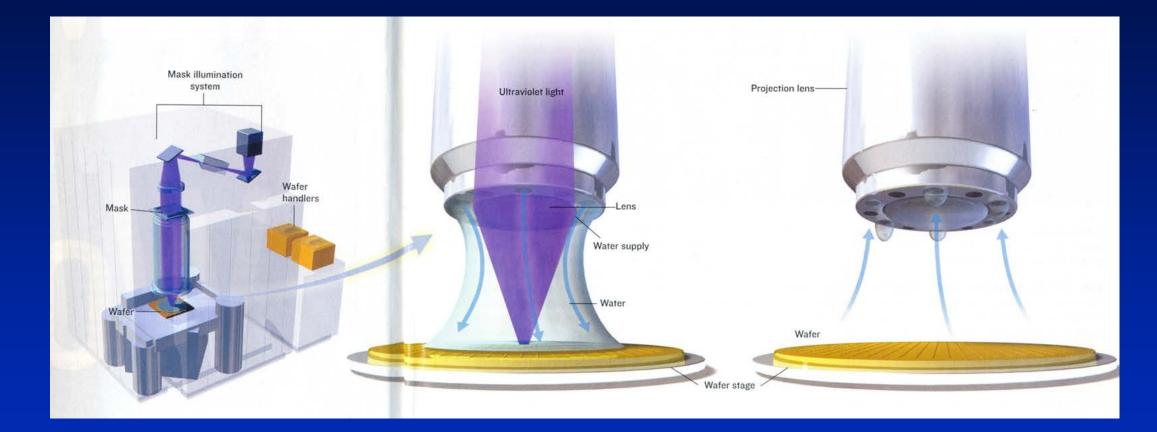
Projected Chip Pricing



Projected Chip Pricing



Getting Wafers Wet



By adding a thin layer of water between the projection lens and the wafer, the immersion system can create features 30 percent smaller.

Photolithography

- Defining the smallest components requires short wavelengths of light.
- Currently, most fabrication processors use extreme ultra-violet light at 193nm.
- Can pass the light through water. The water slows the light (less velocity) shrinking its wavelength. It is estimated that this technique will meet demands for 7 more years.
- On February 20, 2006 IBM Almaden & JSR Micro demonstrated a system using an "unidentified" light slowing liquid yielding patterns 29.9nm wide.

Science News, March 2, 2006

10 Nanometer Technology

- Nov. 15, 2012, Samsung unveiled a 64 gigabyte (GB) multimedia card (eMMC) based on 10 nm technology.
- April 11, 2013, Samsung announced it was mass-producing High-Performance 128-gigabit NAND Flash Memory with 10 nm and 20 nm technology.
- April 2015, TSMC announced that 10 nm production would begin at the end of 2016.
- May 23rd 2015, Samsung Electronics showed off a wafer of 10nm FinFET chips.

Factors Contributing to Advancing Microprocessor Performance

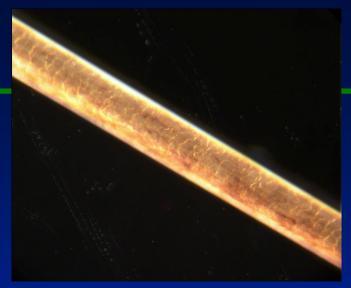
- Shrinking Component Size
- Increasing Speed
- Reducing Circuit Resistance
- New Materials

Factors Contributing to Advancing Microprocessor Performance

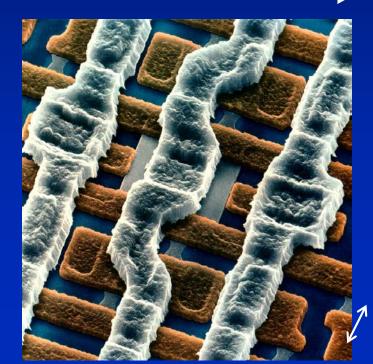
- RISC vs. CISC
- VLIW
- Multi-level Cache
- Parallelism & Pipelining

Factors Contributing to Advancing Microprocessor Performance

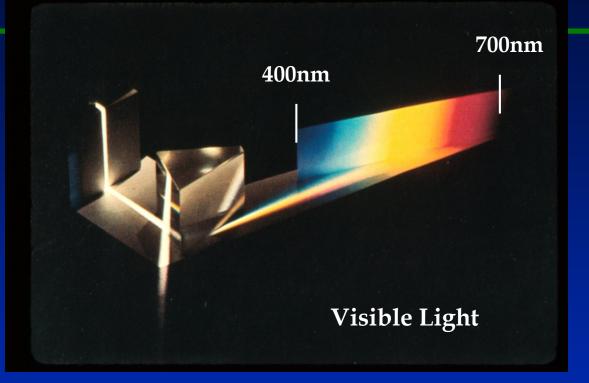
- RISC vs. CISC
- VLIW
- Multi-level Cache
- Parallelism & Pipelining
- Multi-core Technology



Human Hair

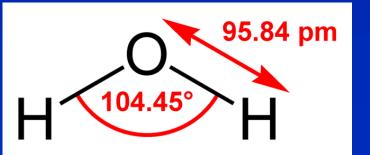


50µm



Integrated Chip

32nm

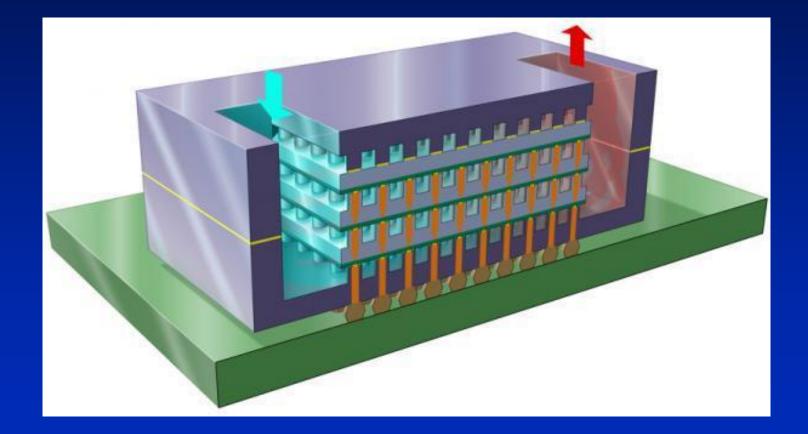


- How long can Moore's Law continue?
- What are the limits to this integrated circuit technology?

"There are two constraints:

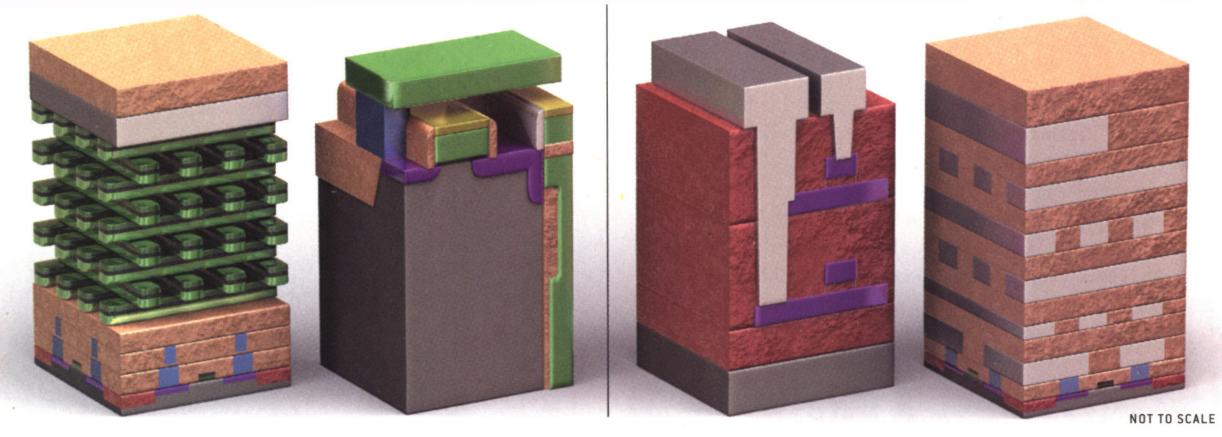
- The finite velocity of light
- The atomic nature of materials"
 - Stephen Hawking

IBM's Chip Stacking Technology



Interior Structure of 3-D chips

3-D Volatile Memory [Matrix Semiconductor] 2-D Random-Access Memory [IBM 256-Megabit] 3-D Logic Circuit [Lab Prototype] 2-D Microprocessor [Advanced Micro Devices Athlon]



Monosilicon substrate Insulators Aluminum wires

Polysilicon

Tungsten plugs Ion-doped silicon Isolation oxides Silicide

Intel's 3D Transistor

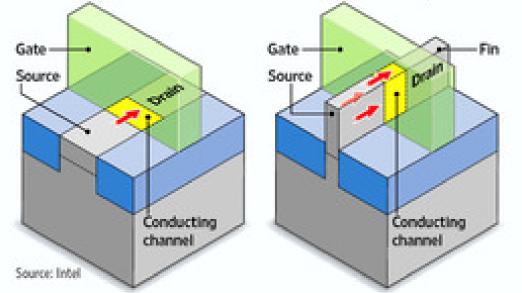
2011

Intel's Move Into 3-D

The chip maker breaks from conventional approaches to make transistors.

Conventional transistor:

Electrons flow between components called a source and a drain, forming a two-dimensional conducting channel. A component called a gate starts and stops the flow, switching a transistor on or off. Intel's new transistor: A fin-like structure rises above the surface of the transistor with the gate wrapped around it, forming conducting channels on three sides. The design takes less space on a chip, and improves speed and reduces power consumption.

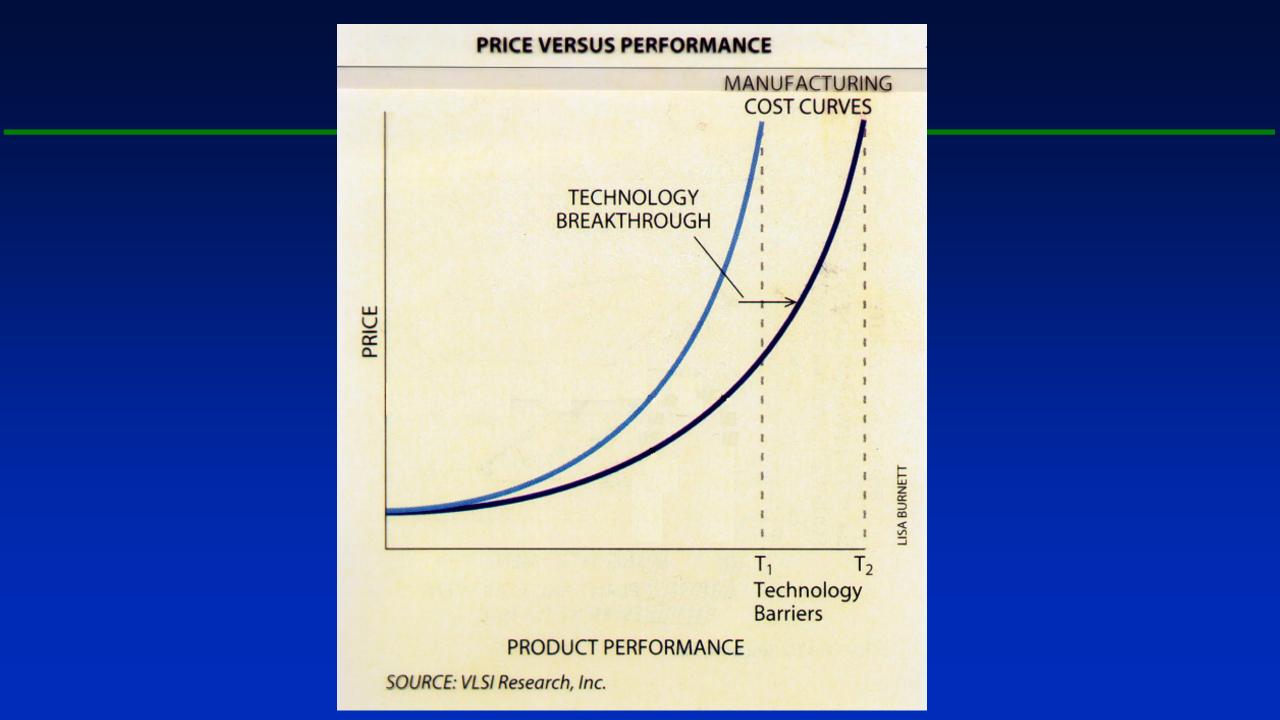


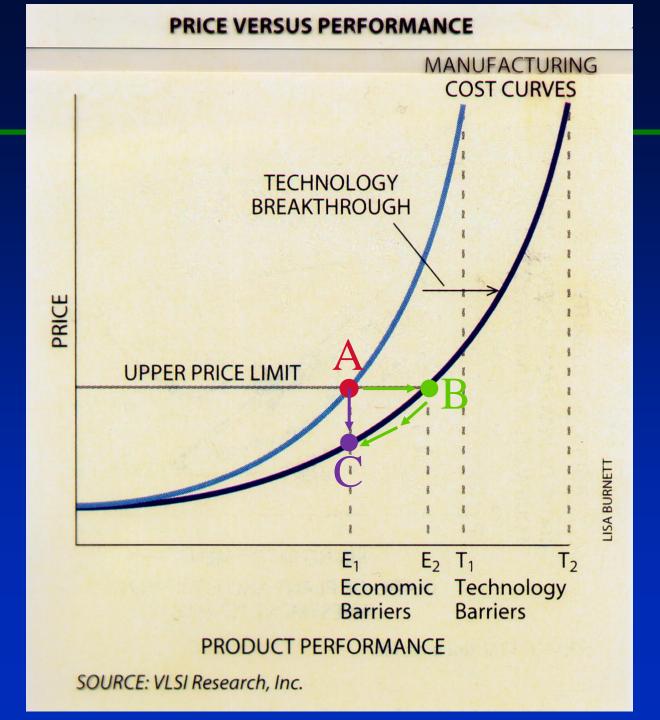
"Every economic era is based on a key abundance and a key scarcity."

> George Gilder, Forbes ASAP, 1992

What are the key scarcities?

Computer Processing Case Studies NBAY 6120 March 6, 2018 Donald P. Greenberg Lecture 2





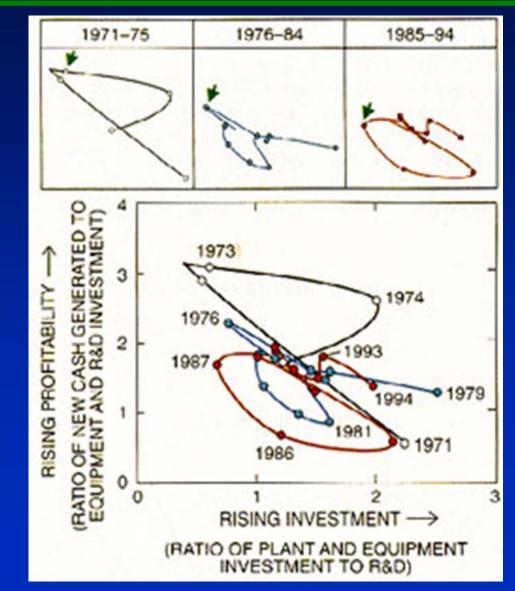
How do you predict what the technology, manufacturing cost, market demand, market supply, and competition will be five years in the future?

Return on Investment (ROI) Model does not work well

Difficulties:

- How long does the product last?
- What is the price (revenue)/unit?
- Exponential change
- Non-linear pricing behavior
- Competition (monopoly pricing)
- Prediction of demand
- Technical obstacles

Profitability vs. Investment in the Computer Industry



Profitability vs. Investment in the Computer Industry

Rising Profitability

Measured by ratio =

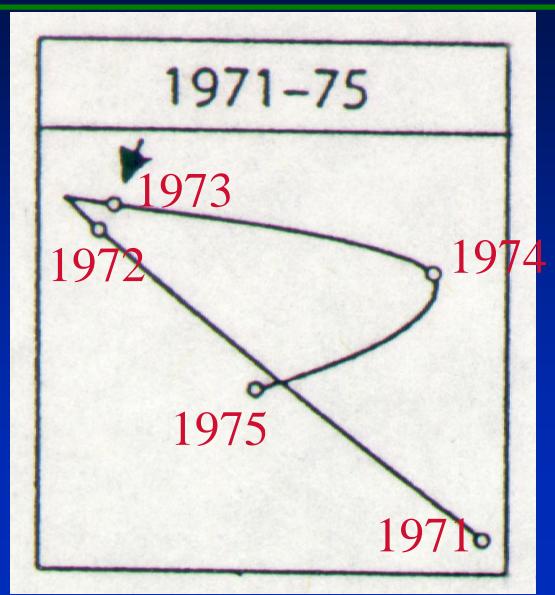
cash generated during year

investments made in new technology previous year

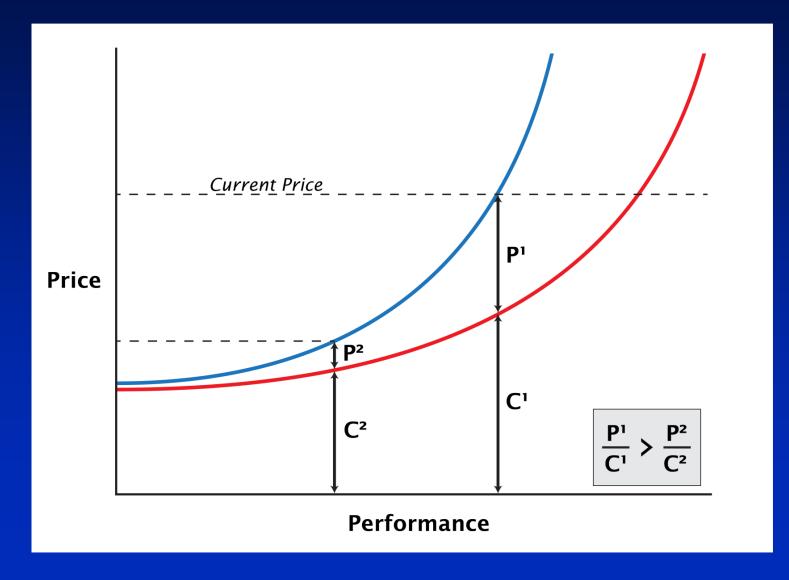
where new technology = new equipment + R & D cash = gross profit (including R & D)

 $\frac{\text{Rising Investment}}{\text{Measured by ratio}} = \frac{\text{plant \& equipment investment}}{\text{R \& D}}$

Profitability vs. Investment



Diminishing Profitability





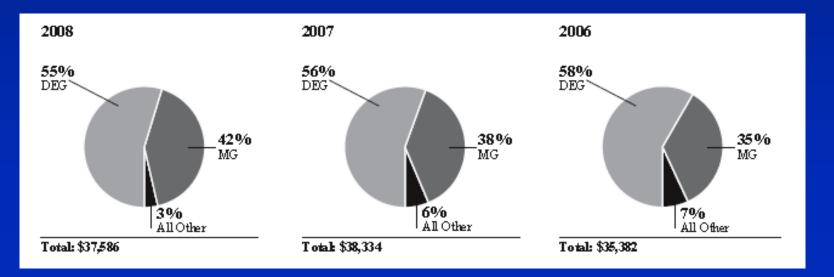


- Mobile microprocessors ASP's are less than desktop microprocessor ASP's.
- In 2007 gross margins were negatively impacted by declining ASP's and higher start-up costs for the new 45nm process technology.
- At the end of 2007, Intel had roughly \$20B cash.





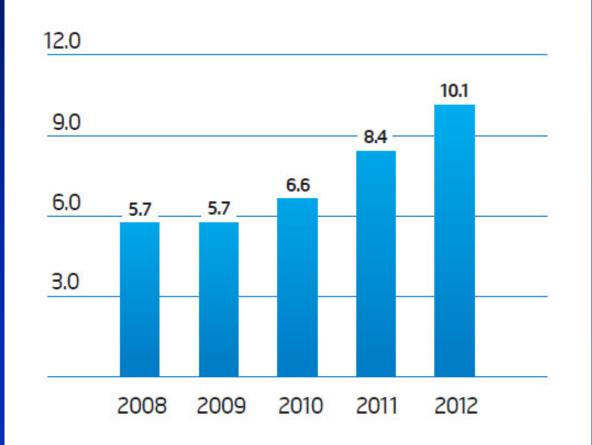
- In 2008 the average selling price for all products continued to decline
- The revenues for the mobility group as contrasted to the digital enterprise group continued to increase



Percentage of Revenue (Dollars in Millions)

Intel Research & Development

Research and Development Dollars in billions



2012

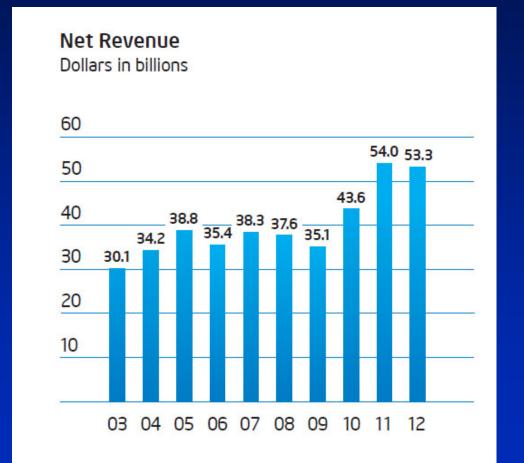
Obama at Intel





Intel Net Revenue

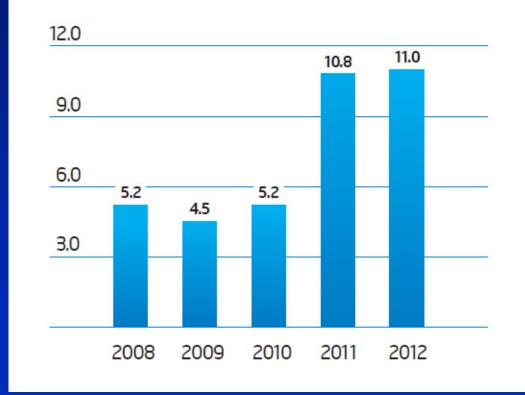




Intel



Capital Additions to Property, Plant and Equipment Dollars in billions







- Intel announced that it would spend \$9B to upgrade four fabrication plants to move to 22nm technology (one in Israel).
- ARM and IBM announced a joint agreement to move to 14nm technology.

Computer Industry Problem



- The high price servers are representing a much smaller percentage of revenue stream
- The prices of laptops and netbook computers are continuing to decrease
- Competition and price wars in the mobile computing segments (mobile phones, smart devices, tablets) are fierce

Intel cancels 14nm Fab 42 in AZ, due to increasing competition from ARM



January 2014, ExtremeTech.com





- Intel again delays 10nm technology. It will depend on revenue increase from Windows 10 and its new Skylake processor.
- The second generation of 14nm production technology had significant yield improvements.
- At the same time, Intel moved to purchase Altera so it could shift from PC's to mobile devices.

Intel's \$7B Investment



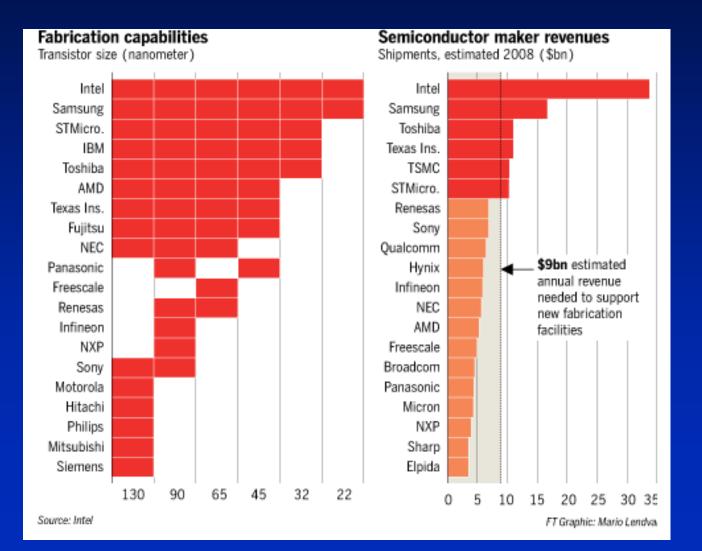
Wall Street Journal, Feb. 8th, 2017

Potential Plans

- 7 nanometer chip technology
- 5 G Networks
- Drones

Fewer companies can deliver smaller and more powerful chips

July 20, 2009



Foundry Model

- Many companies (Integrated Device Manufacturers, IDMs) design and manufacture integrated circuits (efficiency through vertical integration)
- Today, there are many companies that:
 - only design devices (fabless semiconductor companies),
 - as well as *merchant foundries* that only manufacture devices.
- The *foundry model* is a business vision that seeks to optimize productivity.
- In 1987, the world's first dedicated merchant foundry opened its doors: Taiwan Semiconductor Manufacturing Company (TSMC)

TSMC's Customers

- Manufacture's chips for
 - Qualcomm
 - Nvidia
 - Advanced Micro Devices (AMD)
 - Broadcom, Altera
 - > (even some for Intel & Texas Instruments)
 - Apple's A5, A6 for iPad & iPhone
 - Apple's new A8

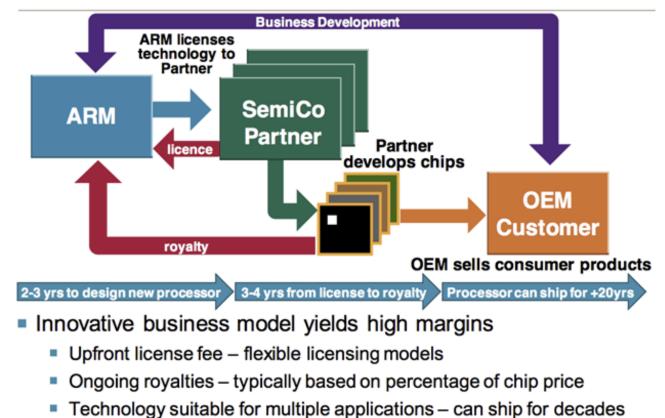
TSMC's Fabrication Plants

2014

- TSMC had four 300mm wafer plants in Taiwan
- TSMC had four 200mm wafer plants in Taiwan
- TSMC had one 200mm wafer plant in Shanghai, Washington State, Singapore, and other smaller plants.

ARM Holdings - Business Model

ARM Business Model



ARM Holdings

- Original name was Acorn Computers
- In 1990 a new customer arrived, Apple: and company was renamed Advanced RISC Machines (ARM)

"Watts are more important then MIPS of FLOPS" - George Gilder

ARM's Customers

- Apple (iPhone 5, iPad, iPhone 5s, iPhone 6, etc.)
- Samsung (Galaxy S4, S5, etc.)
- Qualcomm (Snapdragon)

Japan's Softbank Purchased ARM For \$32B 2016

- Influenced by the growing "Internet of Things" (IOT)
- Price was greater than 40% over the closing stock price

Predicting Demand

How do you predict what the technology, manufacturing cost, market demand, market supply, and competition will be five years in the future?

Marketing & Advertising Strategies in the Computer Industry

In a fast moving technology, how do you market your product?

> *How do you get brand name recognition?*

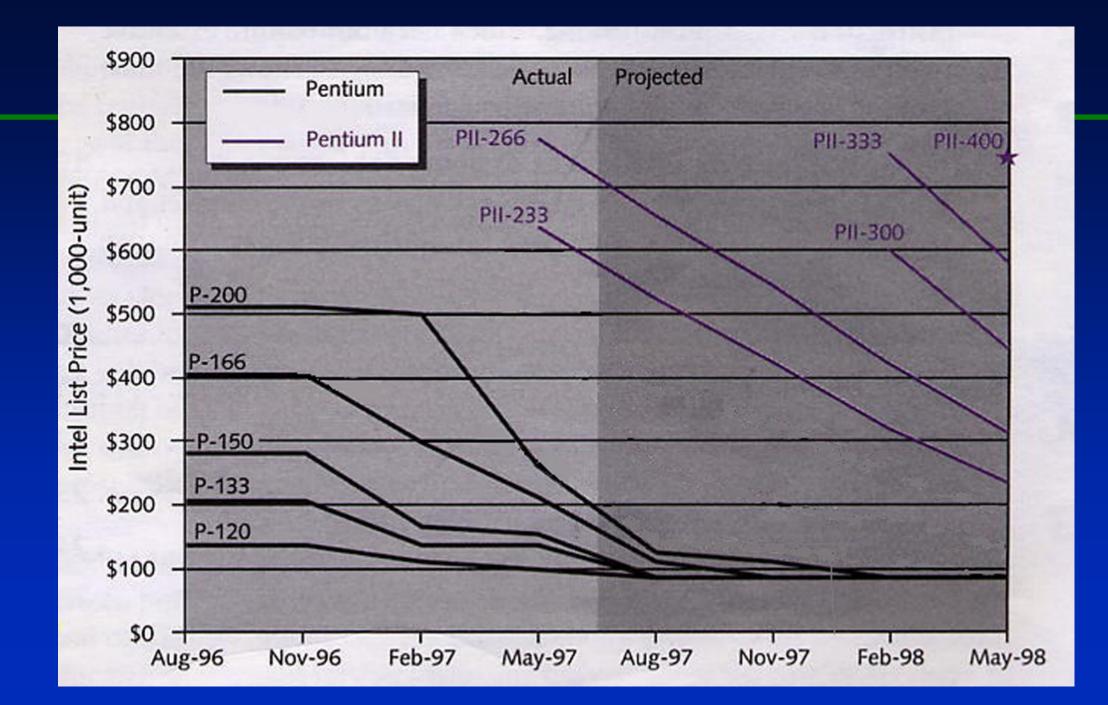
> When do you start advertising?

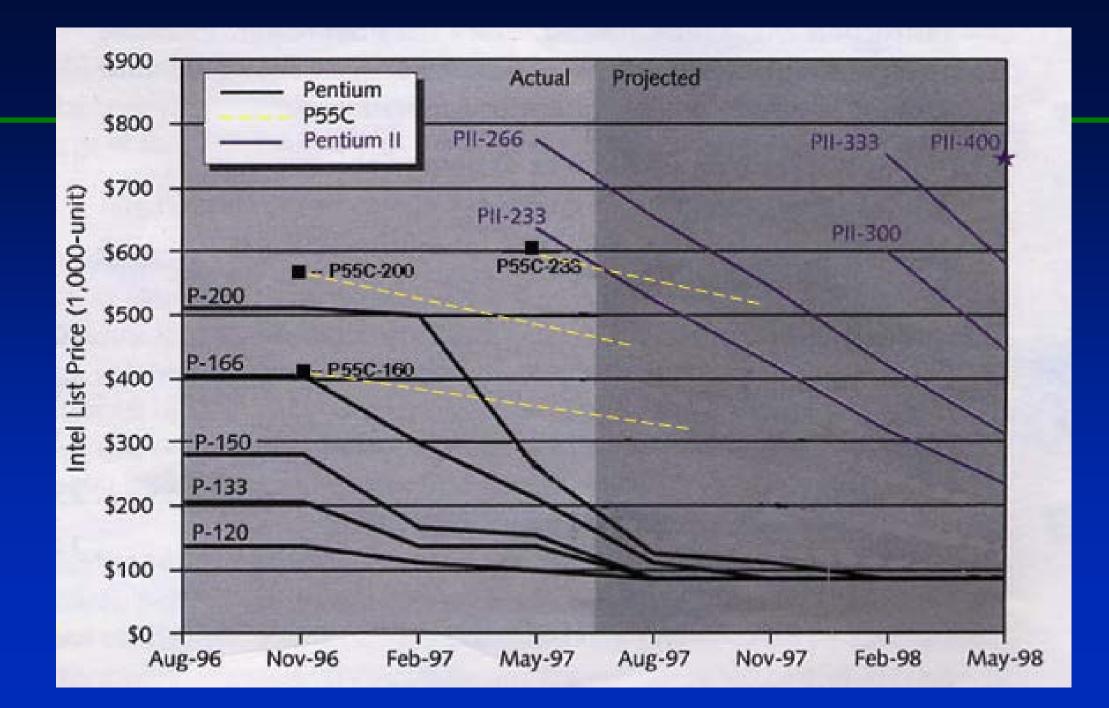
What is MMX?

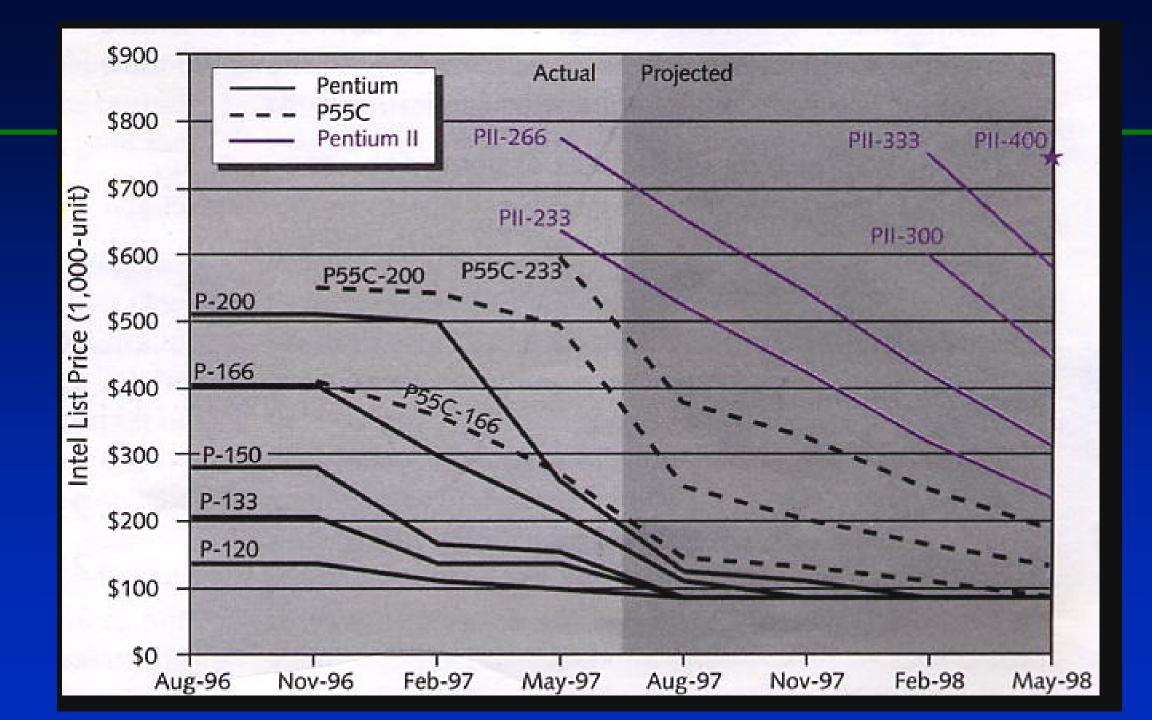
- First major extension to x86 instruction set since 1985
- 57 new instructions to accelerate:

2D & 3D graphics Video

Speech synthesis and recognition







Lessons Learned?

- Need to completely integrate new product development, production capacity, advertising and marketing
- New products need to be introduced frequently to keep ASP constant or at high levels
- Case explains the drive for continually shrinking technology

Moore's Original Article

1965



Source: http://web.eng.fiu.edu/npala/eee6397ex/gordon_moore_1965_article.pdf

Every economic era is based on a key abundance and a key scarcity.

George Gilder, Forbes ASAP, 1992

